# 3.0V/3.3V Microprocessor Supervisory Circuits

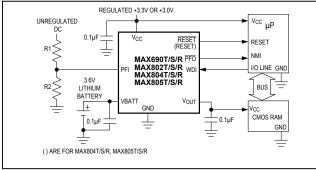
#### **General Description**

These microprocessor ( $\mu P$ ) supervisory circuits reduce the complexity and number of components required for power-supply monitoring and battery-control functions in  $\mu P$  systems. They significantly improve system reliability and accuracy compared to separate ICs or discrete components.

These devices are designed for use in systems powered by 3.0V or 3.3V supplies. See the selector guide in the back of this data sheet for similar devices designed for 5V systems. The suffixes denote different reset threshold voltages: 3.075V (T), 2.925V (S), and 2.625V (R) (see the Reset Threshold section in the Detailed Description). All these parts are available in 8-pin DIP and SO packages. Functions offered in this series are as follows:



# **Typical Operating Circuits**



Typical Operating Circuits continued at at end of data sheet.

#### **Features**

- RESET and RESET Outputs
- Manual Reset Input
- Precision Supply-Voltage Monitor
- 200ms Reset Time Delay
- Watchdog Timer (1.6sec timeout)
- Battery-Backup Power Switching—Battery Can Exceed V<sub>CC</sub> in Normal Operation
- 40μA V<sub>CC</sub> Supply Current
- 1µA Battery Supply Current
- Voltage Monitor for Power-Fail or Low-Battery Warning
- Guaranteed RESET Assertion to V<sub>CC</sub> = 1V
- 8-Pin DIP and SO Packages

#### **Applications**

- Battery-Powered Computers and Controllers
- Embedded Controllers
- Intelligent Instruments
- Critical µP Power Monitoring
- Portable Equipment

#### **Ordering Information**

PART**	TEMP RANGE	PIN-PACKAGE
MAX690_CPA	0°C to +70°C	8 Plastic DIP
MAX690_CSA	0°C to +70°C	8 SO
MAX690_C/D	0°C to +70°C	Dice*
MAX690_EPA	-40°C to +85°C	8 Plastic DIP
MAX690_ESA	-40°C to +85°C	8 SO
MAX690_MJA	-55°C to +125°C	8 CERDIP

#### Ordering Information continued at end of data sheet.

\*Contact factory for dice specifications.

Devices in PDIP and SO packages are available in both leaded and lead(Pb)-free packaging. Specify lead free by adding the + symbol at the end of the part number when ordering. Lead free not available for CERDIP package.

Pin Configuration appears at end of data sheet.



<sup>\*\*</sup>These parts offer a choice of reset threshold voltage. Select the letter corresponding to the desired nominal reset threshold voltage (T = 3.075V, S = 2.925V, R = 2.625V) and insert it into the blank to complete the part number.

# 3.0V/3.3V Microprocessor Supervisory Circuits

## **Absolute Maximum Ratings**

Terminal Voltage (with respect to GND)	C
V <sub>CC</sub> 0.3V to +6.0V	
VBATT0.3V to +6.0V	
All Other Inputs0.3V to the higher of V <sub>CC</sub> or VBATT	
Continuous Input Current	(
V <sub>CC</sub> 100mA	
VBATT18mA	
GND18mA	
Output Current	5
RESET, PFO18mA	L
V <sub>OUT</sub> 100mA	

Continuous Power Dissipation (T <sub>A</sub> = +70°C)
Plastic DIP (derate 9.09mW/°C above +70°C)727mW
SO (derate 5.88mW/°C above +70°C)471mW
CERDIP (derate 8.00mW/°C above +70°C)640mW
Operating Temperature Ranges
MAX690_C _ /MAX704_C _ /MAX80 _ C0°C to +70°C
MAX690_E/MAX704_E/MAX80E40°C to +85°C
MAX690_M/MAX704_M/MAX80M55°C to +125°C
Storage Temperature Range65°C to +160°C
Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **Electrical Characteristics**

 $(V_{CC}=3.17V\ to\ 5.5V\ for\ the\ MAX690T/MAX704T/MAX80\_T,\ V_{CC}=3.02V\ to\ 5.5V\ for\ the\ MAX690S/MAX704S/MAX80\_S,\ V_{CC}=2.72V\ to\ 5.5V\ for\ the\ MAX690R/MAX704R/MAX80\_R;\ VBATT=3.6V;\ T_A=T_{MIN}\ to\ T_{MAX};\ unless\ otherwise\ noted.\ Typical\ values\ are\ at\ T_A=+25^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Voltage Range,		MAX690_C, MAX704_C, MAX80C		1.0		5.5	V
V <sub>CC</sub> , VBATT (Note 1)		MAX690_E/M,	MAX690_E/M, MAX704_E/M, MAX80E/M			5.5	V
			MAX690_C/E, MAX704_C/E, MAX80C/E, V <sub>CC</sub> < 3.6V		40	50	65 μΑ 55
V <sub>CC</sub> Supply Current		$\overline{MR} = V_{CC}$	MAX690_C/E, MAX704_C/E, MAX80C/E, V <sub>CC</sub> < 5.5V		50	65	
(excluding I <sub>OUT</sub> )	ISUPPLY	(MAX704_/ MAX806_)	MAX690_M, MAX704_M, MAX80M, V <sub>CC</sub> < 3.6V		40	55	
			MAX690_M, MAX704_M, MAX80M, V <sub>CC</sub> < 5.5V		50	70	
V <sub>CC</sub> Supply Current in Battery- Backup Mode(excluding I <sub>OUT</sub> )		MR = V <sub>CC</sub> (MAX704_/ MAX806_)	V <sub>CC</sub> = 2.0V, VBATT = 2.3V		25	50	μΑ
VBATT Supply Current, Any		MAX690_C/E, MAX704_C/E, MAX80C/E MAX690_M, MAX704_M, MAX80M			0.4	1	μА
Mode (excluding I <sub>OUT</sub> ) (Note 2)					0.4	10	
Battery Leakage Current		MAX690_C/E, MAX704_C/E, MAX80C/E			0.01	0.5	μΑ
(Note 3)		MAX690_M, M	AX704_M, MAX80M		0.01	5	μΛ
		MAX690_C/E, I <sub>OUT</sub> = 5mA (N	MAX704_C/E, MAX80C/E, ote 4)	V <sub>CC</sub> -0.3	V <sub>CC</sub> -0.015		
		MAX690_C/E, I <sub>OUT</sub> = 50mA	MAX704_C/E, MAX80C/E	V <sub>CC</sub> -0.3	V <sub>CC</sub> -0.15		
V <sub>OUT</sub> Output Voltage		MAX690_M, M. I <sub>OUT</sub> = 5mA (N	AX704_M, MAX80M ote 4)	V <sub>CC</sub> -0.035	V <sub>CC</sub> -0.015		V
		MAX690_M, M. I <sub>OUT</sub> = 50mA	AX704_M, MAX80M	V <sub>CC</sub> -0.35	V <sub>CC</sub> -0.15		
		I <sub>OUT</sub> = 250μA,	V <sub>CC</sub> > 2.5V (Note 4)	V <sub>CC</sub> -0.0015	V <sub>CC</sub> -0.0006		

# 3.0V/3.3V Microprocessor Supervisory Circuits

## **Electrical Characteristics (continued)**

 $(V_{CC} = 3.17V \ to \ 5.5V \ for \ the \ MAX690T/MAX704T/MAX80\_T, \ V_{CC} = 3.02V \ to \ 5.5V \ for \ the \ MAX690S/MAX704S/MAX80\_S, \ V_{CC} = 2.72V \ to \ 5.5V \ for \ the \ MAX690R/MAX704R/MAX80\_R; \ VBATT = 3.6V; \ T_A = T_{MIN} \ to \ T_{MAX}; \ unless \ otherwise \ noted. \ Typical \ values \ are \ at \ T_A = +25^{\circ}C.)$ 

PARAMETER	SYMBOL	CON	DITIONS	MIN	TYP	MAX	UNITS	
V <sub>OUT</sub> in Battery-Backup		I <sub>OUT</sub> = 250μA, VBATT	= 2.3V	VBATT - 0.1	VBATT - 0.034		v	
Mode		I <sub>OUT</sub> = 1mA, VBATT =	I <sub>OUT</sub> = 1mA, VBATT = 2.3V		VBATT -0.14		V	
Battery Switch Threshold,		VBATT - V <sub>CC</sub> , V <sub>SW</sub> >	V <sub>CC</sub> > 1.75V (Note 5)	65	25		mV	
V <sub>CC</sub> Falling	V <sub>SW</sub>	VBATT > V <sub>CC</sub> (Note 6	)	2.30	2.40	2.50	V	
Battery Switch Threshold, V <sub>CC</sub> Rising (Note 7)		This value is identical V <sub>CC</sub> rising	to the reset threshold,				V	
		MAX690T/704T/805T	V <sub>CC</sub> falling	3.00	3.075	3.15		
		WIAX0901/7041/8051	V <sub>CC</sub> rising	3.00	3.085	3.17		
		MAX802T/804T/806T	V <sub>CC</sub> falling	3.00	3.075	3.12		
		WIAA0U21/0U41/0U01	V <sub>CC</sub> rising	3.00	3.085	3.14		
		MAY6000/7040/0050	V <sub>CC</sub> falling	2.85	2.925	3.00		
Reset Threshold (Note 8)	\ \ \ \	MAX690S/704S/805S	V <sub>CC</sub> rising	2.85	2.935	3.02	V	
	V <sub>RST</sub>	MAX802S/804S/806S	V <sub>CC</sub> falling	2.88	2.925	3.00	V	
			V <sub>CC</sub> rising	2.88	2.935	3.02		
		MAX690R/704R/805R	V <sub>CC</sub> falling	2.55	2.625	2.70		
			V <sub>CC</sub> rising	2.55	2.635	2.72		
		MAY002D/004D/006C	V <sub>CC</sub> falling	2.59	2.625	2.70		
		MAX802R/804R/806S		2.59	2.635	2.72		
Reset Timeout Period	t <sub>WP</sub>	V <sub>CC</sub> < 3.6V			200	280	ms	
PFO, RESET Output Voltage	V <sub>OH</sub>	I <sub>SOURCE</sub> = 50μA			V <sub>CC</sub> - 0.05		V	
PFO, RESET Output Short to GND Current (Note 4)	los	V <sub>CC</sub> = 3.3V, V <sub>OH</sub> = 0V	V <sub>CC</sub> = 3.3V, V <sub>OH</sub> = 0V		180	500	μV	
PFO, RESET, RESET Output Voltage	V <sub>OL</sub>	I <sub>SINK</sub> = 1.2mA; MAX690_/704_/802_/806_, V <sub>CC</sub> = V <sub>RST</sub> min; MAX804_/805_, V <sub>CC</sub> = V <sub>RST</sub> max			0.06	0.3	V	
PFO, RESET Output Voltage	V <sub>OL</sub>	VBATT = 0V, V <sub>CC</sub> = 1.0V, I <sub>SINK</sub> = 40μA, MAX690_C, MAX704_C, MAX80C			0.13	0.3	V	
		VBATT = 0V, V <sub>CC</sub> = 1.2V, I <sub>SINK</sub> = 200μA, MAX690_E/M, MAX704_E/M, MAX80E/M			0.17	0.3	V	
RESET Output Leakage		VBATT = 0V,	MAX804_C, MAX805_C	-1		+1		
Current (Note 9)		$V_{CC} = V_{RST}$ min; $V_{RESET} = 0V$ , $V_{CC}$	MAX804_E/M, MAX805_E/M	-10		+10	μΑ	

#### **Electrical Characteristics (continued)**

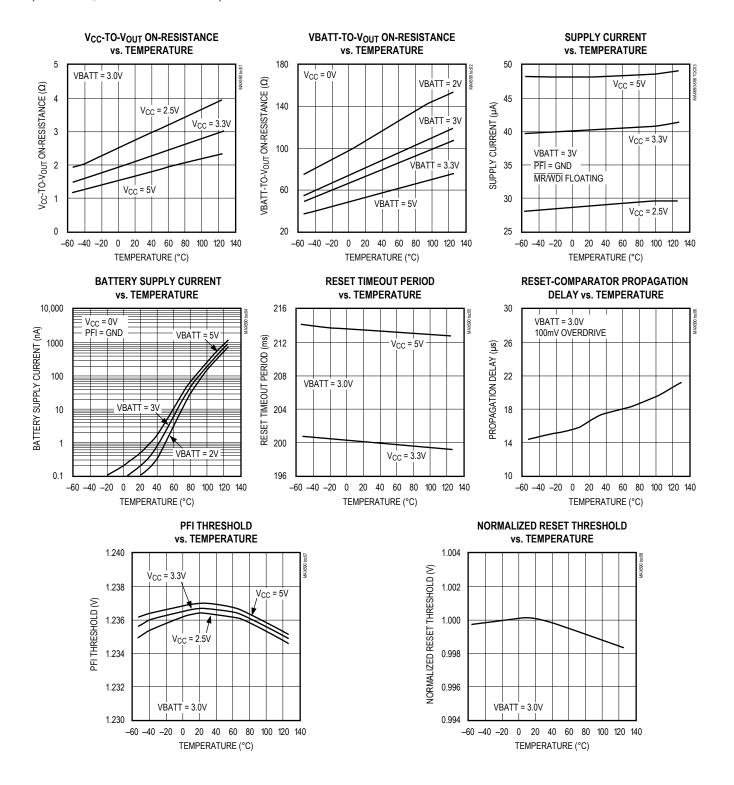
 $(V_{CC} = 3.17V \text{ to } 5.5V \text{ for the MAX690T/MAX704T/MAX80_T}, V_{CC} = 3.02V \text{ to } 5.5V \text{ for the MAX690S/MAX704S/MAX80_S}, V_{CC} = 2.72V \text{ to } 5.5V \text{ for the MAX690R/MAX704R/MAX80_R}; VBATT = 3.6V; T_A = T_{MIN} \text{ to } T_{MAX}; \text{ unless otherwise noted. Typical values are at } T_A = +25C.)$ 

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS	
PFI Input Threshold	V <sub>PFT</sub>	V <sub>CC</sub> < 3.6V V <sub>PFI</sub> falling	MAX802_C/E, MAX804_C/E, MAX806_C/E	1.212	1.237	1.262	V	
		VPFI Iailing	MAX690_/MAX704_/MAX805_	1.187	1.237	1.287		
PFI Input Current		MAX690_C/E, MAX704_C/E, MAX80C/E		-25	2	25	^	
Pri input Current		MAX690_M, N	MAX704_M, MAX80M	-500	2	500	nA	
PFI Hysteresis, PFI Rising	V	V	MAX690_C/E, MAX704_C/E, MAX80C/E		10	20	mV	
	V <sub>PFH</sub>	V <sub>CC</sub> < 3.6V	MAX690_M, MAX704_M, MAX80M		10	25		
DELInout Current		MAX690_C/E, MAX704_C/E, MAX80C/E MAX690_M, MAX704_M, MAX80M		-25	2	25	nA	
PFI Input Current				-500	2	500		
MD beaut Three bods	V <sub>IH</sub>	- MAX704_/MAX806_ only			0.	.7 x V <sub>CC</sub>	V	
MR Input Threshold	V <sub>IL</sub>			0.3 x V <sub>C</sub>	 C			
MR Pulse Width	t <sub>MR</sub>	MAX704_/MA	X806_ only	100	20		ns	
MR to Reset Delay	t <sub>MD</sub>	MAX704_/MA	X806_ only		60	500	ns	
MR Pull-Up Current		MAX704_/MA	X806_ only, $\overline{MR}$ = 0V, $V_{CC}$ = 3V	20	60	350	μΑ	
WDI Input Threshold	V <sub>IH</sub>	MAX690_/MAX802_/MAX804_/MAX805_ only			0.	.7 x V <sub>CC</sub>	V	
WDI IIIput Tillesiloid	V <sub>IL</sub>			0.3 x V <sub>C</sub>	С			
WDI Input Current		0V< V <sub>CC</sub> <	MAX690_C/E, MAX802_C/E, MAX804_C/E, MAX805_C/E	-1	+0.01	+1		
		5.5V	MAX690_M, MAX802_M, MAX804_M, MAX805_M	-10	+0.01	+10	μA	
Watchdog Timeout Period	t <sub>WD</sub>	V <sub>CC</sub> < 3.6V	MAX690/MAX802/MAX804/ MAX805 only	1.12	1.60	2.24	s	
WDI Pulse Width		MAX690_/MA	X802_/MAX804_/MAX805_ only	100	20		ns	

- Note 1: V<sub>CC</sub> supply current, logic input leakage, watchdog functionality (MAX690\_/802\_/805\_/804\_), MR functionality (MAX704\_/806\_), PFI functionality, state of RESET (MAX690\_/704\_/802\_/806\_), and RESET (MAX804\_/805\_) tested at VBATT = 3.6V, and V<sub>CC</sub> = 5.5V. The state of RESET or RESET and PFO is tested at V<sub>CC</sub> = V<sub>CC</sub> min.
- Note 2: Tested at VBATT =  $3.6\overline{V}$ ,  $V_{CC}$  =  $3.5\overline{V}$  and 0V. The battery current will rise to  $10\mu\text{A}$  over a narrow transition window around  $V_{CC}$  =  $1.9\overline{V}$ .
- Note 3: Leakage current into the battery is tested under the worst-case conditions at V<sub>CC</sub> = 5.5V, VBATT = 1.8V and at V<sub>CC</sub> = 1.5V, VBATT = 1.0V.
- Note 4: Guaranteed by design.
- Note 5: When  $V_{SW} > V_{CC} > VBATT$ ,  $V_{OUT}$  remains connected to  $V_{CC}$  until  $V_{CC}$  drops below VBATT. The  $V_{CC}$ -to-VBATT comparator has a small 25mV typical hysteresis to prevent oscillation. For  $V_{CC} < 1.75V$  (typ),  $V_{OUT}$  switches to VBATT regardless of the voltage on VBATT.
- Note 6: When VBATT > V<sub>CC</sub> > V<sub>SW</sub>, V<sub>OUT</sub> remains connected to V<sub>CC</sub> until V<sub>CC</sub> drops below the battery switch threshold (V<sub>SW</sub>).
- Note 7: V<sub>OUT</sub> switches from VBATT to V<sub>CC</sub> when V<sub>CC</sub> rises above the reset threshold, independent of VBATT. Switchover back to V<sub>CC</sub> occurs at the exact voltage that causes RESET to go high (on the MAX804\_/805\_, RESET goes low); however switchover occurs 200ms prior to reset.
- **Note 8:** The reset threshold tolerance is wider for V<sub>CC</sub> rising than for V<sub>CC</sub> falling to accommodate the 10mV typical hysteresis, which prevents internal oscillation.
- Note 9: The leakage current into or out of the RESET pin is tested with RESET asserted (RESET output high impedance).

## **Typical Operating Characteristics**

 $(T_A = +25^{\circ}C, unless otherwise noted.)$ 



### **Pin Description**

	PIN				
MAX690 MAX802	MAX704 MAX806	MAX804 MAX805	NAME	FUNCTION	
1	1	1	V <sub>OUT</sub>	Supply Output for CMOS RAM. When $V_{CC}$ is above the reset threshold, $V_{OUT}$ is connected to $V_{CC}$ through a p-channel MOSFET switch. When $V_{CC}$ falls below $V_{SW}$ and VBATT, VBATT connects to $V_{OUT}$ . Connect to $V_{CC}$ if no battery is used.	
2	2	2	$V_{CC}$	Main Supply Input	
3	3	3	GND	Ground	
4	4	4	PFI	Power-Fail Input. When PFI is less than V <sub>PFT</sub> or when V <sub>CC</sub> falls below V <sub>SW</sub> , <del>PFO</del> goes low; otherwise, <del>PFO</del> remains high. Connect to ground if unused.	
5	5	5	PFO	Power-Fail Output. When PFI is less than V <sub>PFT</sub> , or V <sub>CC</sub> falls below V <sub>SW</sub> , PFO goes low; otherwise, PFO remains high. Leave open if unused.	
6	_	6	WDI	Watchdog Input. If WDI remains high or low for 1.6s, the internal watchdog timer runs out and reset is triggered. The internal watchdog timer clears while reset is asserted or when WDI sees a rising or falling edge. The watchdog function cannot be disabled.	
_	6	_	MR	Manual Reset Input. A logic low on $\overline{MR}$ asserts reset. Reset remains asserted as long as $\overline{MR}$ is low and for 200ms after $\overline{MR}$ returns high. This active-low input has an internal 70 $\mu$ A pullup current. It can be driven from a TTL or CMOS logic line, or shorted to ground with a switch. Leave open if unused.	
7	7	_	RESET	Active-Low Reset Output. Pulses low for 200ms when triggered, and stays low whenever $V_{CC}$ is below the reset threshold or when $\overline{MR}$ is a logic low. It remains low for 200ms after either $V_{CC}$ rises above the reset threshold, the watchdog triggers a reset, or $\overline{MR}$ goes from low to high.	
		7	RESET	Active-High, Open-Drain Reset Output is the inverse of RESET.	
8	8	8	VBATT	Backup-Battery Input. When $V_{CC}$ falls below $V_{SW}$ and VBATT, $V_{OUT}$ switches from $V_{CC}$ to VBATT. When $V_{CC}$ rises above the reset threshold, $V_{OUT}$ reconnects to $V_{CC}$ . VBATT may exceed $V_{CC}$ . Connect to $V_{CC}$ if no battery is used.	

#### **Detailed Description**

#### **Reset Output**

A microprocessor's ( $\mu$ P's) reset input starts the  $\mu$ P in a known state. These  $\mu$ P supervisory circuits assert reset to prevent code execution errors during power-up, power-down, brownout conditions, or a watchdog timeout.

RESET is guaranteed to be a logic low for 0V <  $V_{CC}$  <  $V_{RST}$ , provided that VBATT is greater than 1V. Without a backup battery, RESET is guaranteed valid for  $V_{CC}$  > 1V. Once  $V_{CC}$  exceeds the reset threshold, an internal timer keeps RESET low for the reset timeout period; after this interval, RESET goes high (Figure 2).

If a brownout condition occurs ( $V_{CC}$  dips below the reset threshold),  $\overline{RESET}$  goes low. Each time  $\overline{RESET}$  is asserted, it stays low for the reset timeout period. Any time  $V_{CC}$  goes below the reset threshold, the internal timer restarts.

The watchdog timer can also initiate a reset. See the *Watchdog Input* section.

The MAX804\_/MAX805\_ active-high RESET output is open drain, and the inverse of the MAX690\_/MAX704\_/ MAX802\_/MAX806\_ RESET output.

#### **Reset Threshold**

The MAX690T/MAX704T/MAX805T are intended for 3.3V systems with a  $\pm 5\%$  power-supply tolerance and a 10% system tolerance. Except for watchdog faults, reset will not assert as long as the power supply remains above 3.15V (3.3V - 5%). Reset is guaranteed to assert before the power supply falls below 3.0V.

The MAX690S/MAX704S/MAX805S are designed for  $3.3V \pm 10\%$  power supplies. Except for watchdog faults, they are guaranteed not to assert reset as long as the supply remains above  $3.0V \ (3.3V - 10\%)$ . Reset is guaranteed to assert before the power supply falls below  $2.85V \ (V_{CC} - 14\%)$ .

The MAX690R/MAX704R/MAX805R are optimized for monitoring 3.0V  $\pm 10\%$  power supplies. Reset will not occu, until V<sub>CC</sub> falls below 2.7V (3.0V - 10%), but is guaranteed to occur before the supply falls below 2.59V (3.0V - 14%).

The MAX802R/S/T, MAX804R/S/T, and MAX806R/S/T are respectively similar to the MAX690R/S/T, MAX805R/S/T, and MAX704R/S/T, but with tightened reset and power-fail threshold tolerances.

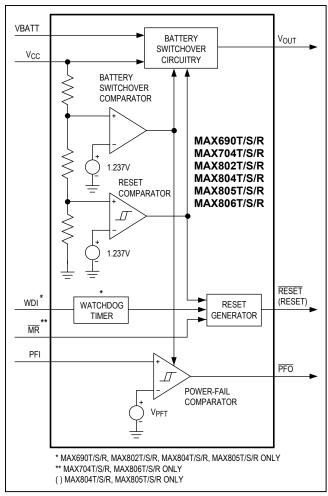


Figure 1. Block Diagram

#### Watchdog Input (MAX690\_/802\_/804\_/805\_)

The watchdog circuit monitors the  $\mu P$ 's activity. If the  $\mu P$  does not toggle the watchdog input (WDI) within 1.6sec, a reset pulse is triggered. The internal 1.6sec timer is cleared by either a reset pulse or by a transition (low-to-high or high-to-low) at WDI. If WDI is tied high or low, a RESET pulse is triggered every 1.8sec (twD plus tRS).

As long as reset is asserted, the timer remains cleared and does not count. As soon as reset is deasserted, the timer starts counting. Unlike the 5V MAX690 family, the watchdog function **cannot** be disabled.

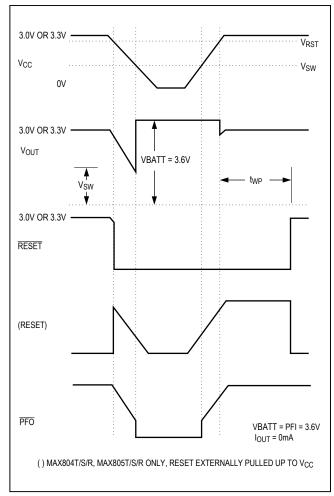


Figure 2. Timing Diagram

#### **Power-Fail Comparator**

The PFI input is compared to an internal reference. If PFI is less than  $V_{PFT}$ ,  $\overline{PFO}$  goes low. The power-fail comparator is intended for use as an undervoltage detector to signal a failing power supply. However, the comparator does not need to be dedicated to this function because it is completely separate from the rest of the circuitry.

The power-fail comparator turns off and  $\overline{PFO}$  goes low when  $V_{CC}$  falls below  $V_{SW}$  on power-down. The power-fail comparator turns on as  $V_{CC}$  crosses  $V_{SW}$  on power-up. If the comparator is not used, connect PFI to ground and leave  $\overline{PFO}$  unconnected.  $\overline{PFO}$  can be connected to  $\overline{MR}$  on the MAX704\_/MAX806\_ so that a low voltage on PFI will generate a reset (Figure 5b).

#### **Backup-Battery Switchover**

In the event of a brownout or power failure, it may be necessary to preserve the contents of RAM. With a back-up battery installed at VBATT, the devices automatically switch RAM to backup power when V<sub>CC</sub> falls.

This family of  $\mu P$  supervisors (designed for 3.3V and 3V systems) doesn't always connect VBATT to  $V_{OUT}$  when VBATT is greater than  $V_{CC}$ . VBATT connects to  $V_{OUT}$  (through a 140 $\Omega$  switch) when  $V_{CC}$  is below  $V_{SW}$  and VBATT is greater than  $V_{CC}$ , or when  $V_{CC}$  falls below 1.75V (typ) regardless of the VBATT voltage. This is done to allow the backup battery (e.g., a 3.6V lithium cell) to have a higher voltage than  $V_{CC}$ .

Switchover at V<sub>SW</sub> (2.40V) ensures that battery-backup mode is entered before V<sub>OUT</sub> gets too close to the 2.0V minimum required to reliably retain data in CMOS RAM. Switchover at higher V<sub>CC</sub> voltages would decrease backup-battery life. When V<sub>CC</sub> recovers, switchover is deferred until V<sub>CC</sub> rises above the reset threshold (V<sub>RST</sub>) to ensure a stable supply. V<sub>OUT</sub> is connected to V<sub>CC</sub> through a 3 $\Omega$  PMOS power switch.

#### **Manual Reset**

A logic low on  $\overline{MR}$  asserts reset. Reset remains asserted while  $\overline{MR}$  is low, and for  $t_{WP}$  (200ms) after  $\overline{MR}$  returns high. This input has an internal  $70\mu A$  pullup current, so it can be left open if it is not used.  $\overline{MR}$  can be driven with TTL or CMOS logic levels, or with open-drain/collector outputs. Connect a normally open momentary switch from  $\overline{MR}$  to GND to create a manual-reset function; external debounce circuitry is not required.

Table 1. Input and Output Status in Battery-Backup Mode

PIN NAME	STATUS
V <sub>OUT</sub>	Connected to VBATT through an internal $140\Omega$ switch
V <sub>CC</sub>	Disconnected from V <sub>OUT</sub>
PFI	The power-fail comparator is disabled when $V_{CC} < V_{SW}$
PFO	Logic low when V <sub>CC</sub> < V <sub>SW</sub> or PFI < V <sub>PFT</sub>
WDI	The watchdog timer is disabled
MR	Disabled
RESET	Low logic
RESET	High impedance
VBATT	Connected to V <sub>OUT</sub>

#### **Applications Information**

These  $\mu P$  supervisory circuits are not short-circuit protected. Shorting  $V_{OUT}$  to ground—excluding power-up transients such as charging a decoupling capacitor—destroys the device. Decouple both  $V_{CC}$  and VBATT pins to ground by placing  $0.1\mu F$  capacitors as close as possible to the device.

#### Using a SuperCap as a Backup Power Source

SuperCaps are capacitors with extremely high capacitance values (e.g., order of 0.47F) for their size. Figure 3 shows two ways to use a SuperCap as a backup power source. The SuperCap may be connected through a diode to the 3V input (Figure 3a) or, if a 5V supply is also available, the SuperCap may be charged up to the 5V supply (Figure 3b) allowing a longer backup period. Since VBATT can exceed  $V_{CC}$  while  $V_{CC}$  is a bove the reset threshold, there are no special precautions when using these  $\mu P$  supervisors with a SuperCap.

#### **Operation without a Backup Power Source**

These  $\mu P$  supervisors were designed for battery-backed applications. If a backup battery is not used, connect both VBATT and  $V_{OUT}$  to  $V_{CC}$ , or use a different  $\mu P$  supervisor such as the MAX706T/S/R or MAX708T/S/R.

#### Replacing the Backup Battery

The backup power source can be removed while  $V_{CC}$  remains valid, if VBATT is decoupled with a 0.1 $\mu$ F capacitor to ground, without danger of triggering RESET/RESET. As long as  $V_{CC}$  stays above  $V_{SW}$ , battery-backup mode cannot be entered.

# Adding Hysteresis to the Power-Fail Comparator

The power-fail comparator has a typical input hysteresis of 10mV. This is sufficient for most applications where a power-supply line is being monitored through an external voltage divider (see the *Monitoring an Additional Power Supply* section).

If additional noise margin is desired, connect a resistor between  $\overline{PFO}$  and PFI as shown in Figure 4a. Select the ratio of R1 and R2 such that PFI sees 1.237V ( $V_{PFT}$ ) when  $V_{IN}$  falls to its trip point ( $V_{TRIP}$ ). R3 adds the hysteresis and will typically be more than 10 times the value of R1 or R2. The hysteresis window extends both above ( $V_H$ ) and below ( $V_L$ ) the original trip point ( $V_{TRIP}$ ).

Connecting an ordinary signal diode in series with R3, as shown in Figure 4b, causes the lower trip point  $(V_L)$  to

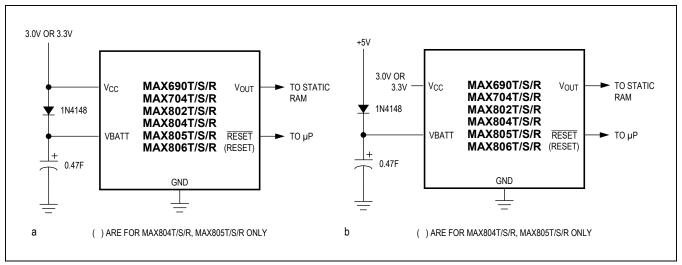


Figure 3. Using a SuperCap as a Backup Power Source

coincide with the trip point without hysteresis ( $V_{TRIP}$ ), so the entire hysteresis window occurs above  $V_{TRIP}$ . This method provides additional noise margin without compromising the accuracy of the power-fail threshold when the monitored voltage is falling. It is useful for accurately detecting when a voltage falls past a threshold.

The current through R1 and R2 should be at least  $1\mu A$  to ensure that the 25nA (max over extended temperature range) PFI input current does not shift the trip point. R3 should be larger than  $10k\Omega$  so it does not load down the  $\overline{PFO}$  pin. Capacitor C1 adds additional noise rejection.

#### Monitoring an Additional Power Supply

These  $\mu P$  supervisors can monitor either positive or negative supplies using a resistor voltage divider to PFI.  $\overline{PFO}$  can be used to generate an interrupt to the  $\mu P$  (Figure 5). Connecting  $\overline{PFO}$  to  $\overline{MR}$  on the MAX704 and MAX806 causes reset to assert when the monitored supply goes out of tolerance. Reset remains asserted as long as  $\overline{PFO}$  holds  $\overline{MR}$  low, and for 200ms after  $\overline{PFO}$  goes high.

# Interfacing to µPs with Bidirectional Reset Pins

μPs with bidirectional reset pins, such as the Motorola 68HC11 series, can contend with the MAX690\_/MAX704\_/ MAX802\_/MAX806\_  $\overline{\text{RESET}}$  output. If, for example, the  $\overline{\text{RESET}}$  output is driven high and the μP wants to pull it low, indeterminate logic levels may result. To correct this, connect a 4.7kΩ resistor between the  $\overline{\text{RESET}}$  output and the μP reset I/O, as in Figure 6. Buffer the  $\overline{\text{RESET}}$  output to other system components.

#### **Negative-Going V<sub>CC</sub> Transients**

While issuing resets to the  $\mu P$  during power-up, power-down, and brownout conditions, these supervisors are relatively immune to short-duration negative-going  $V_{CC}$  transients (glitches). It is usually undesirable to reset the  $\mu P$  when  $V_{CC}$  experiences only small glitches.

Figure 7 shows maximum transient duration vs. reset-comparator overdrive, for which reset pulses are **not** generated. The graph was produced using negative-going  $V_{CC}$  pulses, starting at 3.3V and ending below the reset threshold by the magnitude indicated (reset comparator overdrive). The graph shows the maximum pulse width a negative-going  $V_{CC}$  transient may typically have without causing a reset pulse to be issued. As the amplitude of the transient increases (i.e., goes farther below the reset threshold), the maximum allowable pulse width decreases. Typically, a  $V_{CC}$  transient that goes 100mV below the reset threshold and lasts for 40 $\mu$ s or less will not cause a reset pulse to be issued.

A 100nF bypass capacitor mounted close to the  $V_{CC}$  pin provides additional transient immunity.

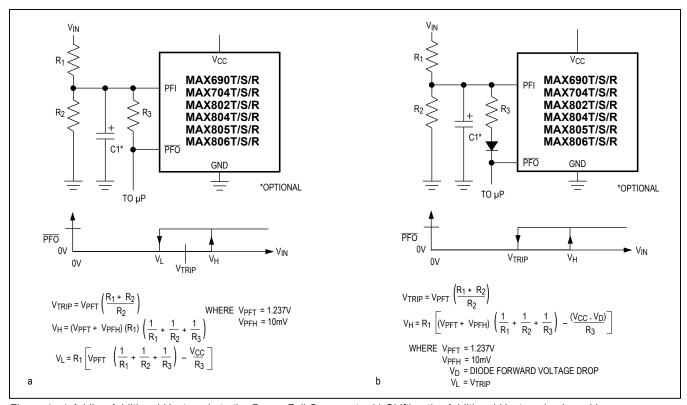


Figure 4. a) Adding Additional Hysteresis to the Power-Fail Comparator b) Shifting the Additional Hysteresis above V<sub>PFT</sub>

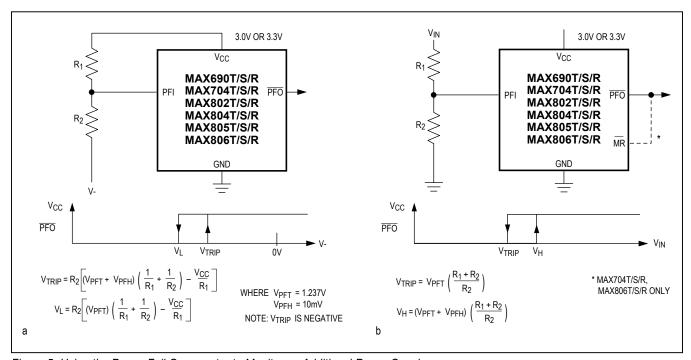


Figure 5. Using the Power-Fail Comparator to Monitor an Additional Power Supply

# 3.0V/3.3V Microprocessor Supervisory Circuits

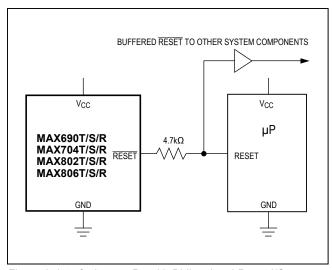


Figure 6. Interfacing to µPs with Bidirectional Reset I/O

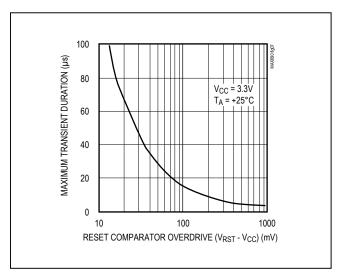


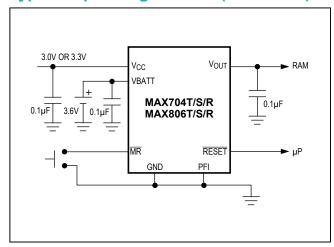
Figure 7. Maximum Transient Duration without Causing a Reset Pulse vs. Reset Comparator Overdrive

#### **Chip Information**

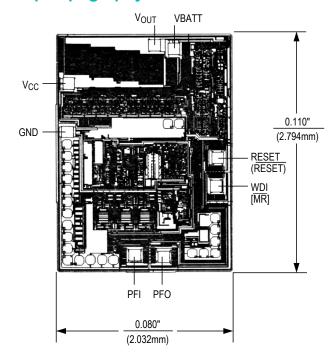
TRANSISTOR COUNT: 802;

SUBSTRATE IS CONNECTED TO THE HIGHER OF  $V_{CC}$  OR VBATT, AND MUST BE FLOATED IN ANY HYBRID DESIGN.

## **Typical Operating Circuits (continued)**



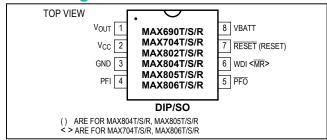
### **Chip Topography**



- ( ) ARE FOR MAX804T/S/R, MAX805T/S/R.
- [] ARE FOR MAX704T/S/R, MAX806T/S/R.

# 3.0V/3.3V Microprocessor Supervisory Circuits

#### **Pin Configuration**



#### **Package Information**

For the latest package outline information and land patterns, go to <a href="https://www.maximintegrated.com/packages">www.maximintegrated.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE e CODE	OUTLINE NO.	LAND PATTERN NO.
8 PDIP	P8+2	21-0043	_
8 CDIP	J8+2	21-0045	_
8 SOIC	S8+4	21-0041	90-0096

#### **Ordering Information (continued)**

		-
PART**	TEMP RANGE	PIN-PACKAGE
MAX704_CPA	0°C to +70°C	8 Plastic DIP
MAX704_CSA	0°C to +70°C	8 SO
MAX704_C/D	0°C to +70°C	Dice*
MAX704_EPA	-40°C to +85°C	8 Plastic DIP
MAX704_ESA	-40°C to +85°C	8 SO
MAX704_MJA	-55°C to +125°C	8 CERDIP
MAX802_CPA	0°C to +70°C	8 Plastic DIP
MAX802_CSA	0°C to +70°C	8 SO
MAX802_C/D	0°C to +70°C	Dice*
MAX802_EPA	-40°C to +85°C	8 Plastic DIP
MAX802_ESA	-40°C to +85°C	8 SO
MAX802_MJA	-55°C to +125°C	8 CERDIP
MAX804_CPA	0°C to +70°C	8 Plastic DIP
MAX804_CSA	0°C to +70°C	8 SO
MAX804_C/D	0°C to +70°C	Dice*
MAX804_EPA	-40°C to +85°C	8 Plastic DIP
MAX804_ESA	-40°C to +85°C	8 SO
MAX804_MJA	-55°C to +125°C	8 CERDIP
MAX805_CPA	0°C to +70°C	8 Plastic DIP
MAX805_CSA	0°C to +70°C	8 SO
MAX805_C/D	0°C to +70°C	Dice*
MAX805_EPA	-40°C to +85°C	8 Plastic DIP
MAX805_ESA	-40°C to +85°C	8 SO
MAX805_MJA	-55°C to +125°C	8 CERDIP
MAX806_CPA	0°C to +70°C	8 Plastic DIP
MAX806_CSA	0°C to +70°C	8 SO
MAX806_C/D	0°C to +70°C	Dice*
MAX806_EPA	-40°C to +85°C	8 Plastic DIP
MAX806_ESA	-40°C to +85°C	8 SO
MAX806_MJA	-55°C to +125°C	8 CERDIP

<sup>\*</sup>Contact factory for dice specifications.

Devices in PDIP and SO packages are available in both leaded and lead(Pb)-free packaging. Specify lead free by adding the + symbol at the end of the part number when ordering. Lead free not available for CERDIP package.

<sup>\*\*</sup>These parts offer a choice of reset threshold voltage. Select the letter corresponding to the desired nominal reset threshold voltage (T = 3.075V, S = 2.925V, R = 2.625V) and insert it into the blank to complete the part number.

# 3.0V/3.3V Microprocessor **Supervisory Circuits**

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
3	4/15	No /V OPNs in <i>Ordering Information</i> ; deleted Automotive Systems in <i>Applications Information</i> section; added <i>Package Information</i> and <i>Revision History</i> tables	1, 12, 13

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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